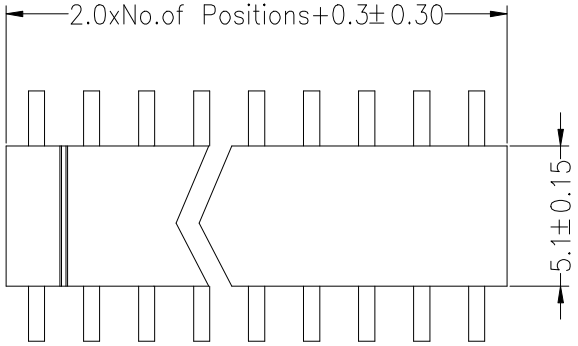
HSF RoHS

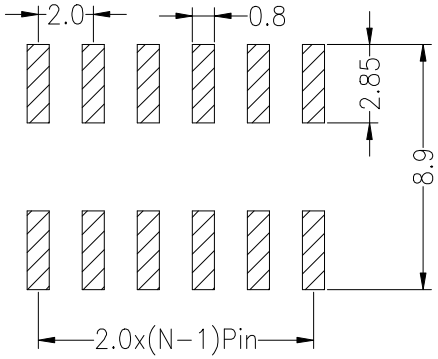
FILE NO :E362810

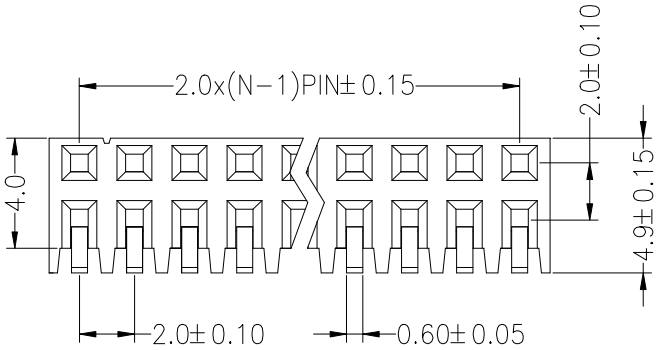
SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

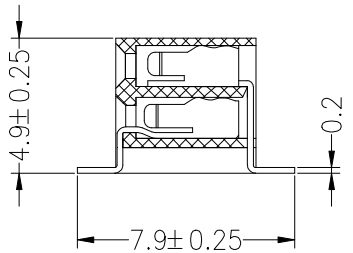
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)




Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)




## *Ordering Information*

**2349 02 XX X N XX M U X 0X**

| | | | | | | | | |
|---|---|---|---|---|---|---|---|---|
| No.of Pins 2−40 | Insulator Material Option | | Post | Contact Plating | | | | Packing |
| | C=BK−PA6T | | W=With Post | G1:Gold Flash | | | | T=Tube |
| | D=BK−PA46 | | N=W/O Post | G3:2U" Gold | | | | P=Tube |
| | E=BK−PA9T | | | G4:3U" Gold | | | | R=Reel |
| | F=BK−LCP | | | G5:5U" Gold | | | | |
| | | | | G6:10U" Gold | | | | |
| | | | | G7:15U" Gold | | | | |
| | | | | S0:Gold Flash/Tin | | | | |
| | | | | SN:Tin | | | | |

| REV | DATE | MODIFICATION DESCRIPTION | CHANGE |
|---|---|---|---|
| | | | |
| | | | |
| | | | |
| A0 | 2018.04.18 | NEW DRAWING | |

| OPERATION | |
|---|---|
| X.X | ± 0.30 |
| X.XX | ± 0.20 |
| X.XXX | ± 0.10 |
| Angle | ± 3° |
| DIM | TOL |

| | | |
|---|---|---|
| DRAW | Liu Miao | 18.04.18 |
| CHECK | | |
| APPROVE | | |

| | |
|---|---|
| SCALE | FIT |
| UNIT | mm |
| SIZE | A4 |
| SHEET | 1/1 |
| PROJ. | |

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

| | |
|---|---|
| PART NO. | 234902XXXNXXMUX0X |
| TITLE: | 2.0PF H4.9mm 2xNpin SMT Side Entry |